













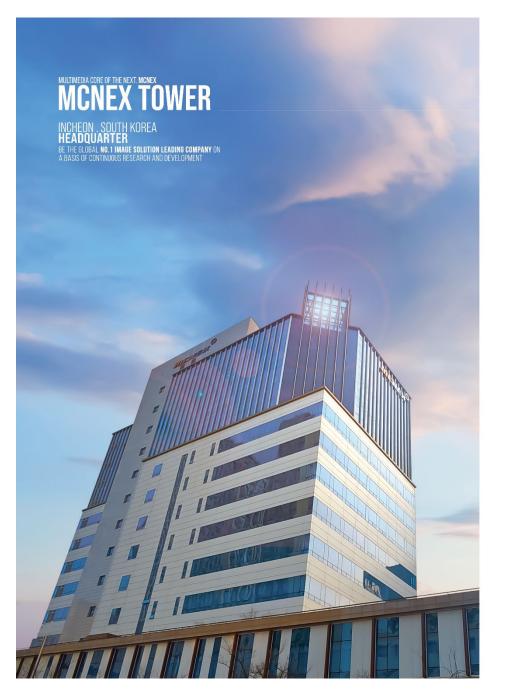




MCNEX'S 9 CONSECUTIVE YEARS OF CES 2023 CES | INC. NEXT

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MCNEX TOWER. 13-39, SONGDOGWAHAK-RO 16BEON-GIL, YEONSU-GU, INCHEON, REPUBLIC OF KOREA



RELIABLE CORE TECHNOLOGY AND SOLUTIONS

<u> </u>		🚘 💿 🍳 🔲 lỗt
COMPANY NAME	MCNEX Co., Ltd.	REVENUE USD1.0B in 2022
HEADQUARTER	Incheon, South Korea	IPO Listed on Korean exchange market (KOSPI) in 202
MAIN FACTORY	Ninh Binh, Vietnam	CERTIFIED IATF 16949 IN 2018
ESTABLISHED	Dec. 2004	

AUTOMOTIVE SOLUTION

Multi interface camera module	Shark Antenna camera system	Dual scanning camera
AHD, LVDS(GMSL, FPD-link), Ethernet, etc.	In-cabin camera system: DMS, OMS	High resolution camera: 7.4MP, 8MP
ADAS & Autonomous driving camera applications	FRU (Face Recognition unit) system	Fingerprint sensing system
SVM, MFC, Tri-focal camera system, Dual camera, etc.	DVRS system: FHD, QHD	ToF camera

MOBILE SOLUTION

SMART PHONE CAMERA MODULE	ACTUATOR	BIOMETRIC MODULE
Single, Dual, Triple, Quadruple camera	VCM, Encoder, OIS	Iris, Face recognition camera
OIS, Folded zoom, ToF camera	Folded zoom	Fingerprint & Body temp. Sensing module. Skin sensor module

SYSTEM SOLUTION

Dashcam, Golf range finder, Network Camera, Medical camera, AR/VR/MR camera, USB camera

EMS (ELECTRONICS MANUFACTURING SERVICE)

Manufacturing service for all kinds of electronics items

MAIN CUSTOMER



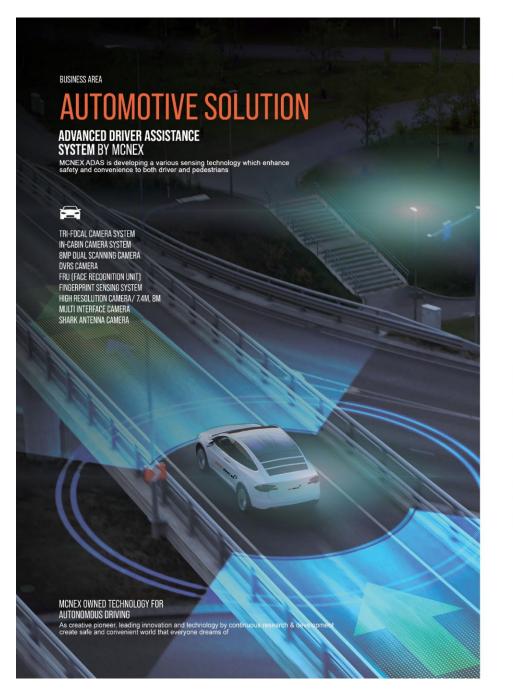


■ R&D ■ Manufacturing ■ Sales ■ FAE(Field Application Engineer)

SOUTH KOREA, HEADQUARTER, MCNEX TOWER

NINHBINH, VIETNAM FACTORY I.II, III.IV

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CATEGORY

CAMERA

ECU





ITEM	SPECIFICATION
Resolution	1920 * 1080
Image Sensor	CMOS FHD SENSOR
Frame Rate	60fps
View Angle	H:30° / 60° / 120°
Output Format	LVDS (PoC)
Power	DC12V (±2.0V)
Image Format	RAW Data
Operating Temp.	-40 ~ +105°C













CATEGORY	ITEM	SPECIFICATION	
	Input Voltage	DC9V ~ DC25V	
CAMERA	Fov(H)	Wide: 120° Tele: 15°	
/	Pixel Resolution	8M pixel	
ECU	Video Output	LVDS(PoC)	
	Data Output	CAN	
	428	=	
SENSING	PD, VD, TLR, TSR	8	
	(0)	-	





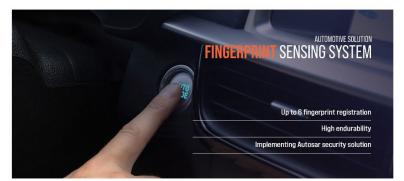
CATEGORY	ITEM	SPECIFICATION	
	Camera	FHD CMOS	
	Sensor Format 1/2.8 inch		
	Resolution	1920*1080@30fps	
CAMERA	Pixel Size	2.9um * 2.9um	
	Fov(H)	95°	
	LENS F-Number	F2.0	
	Video output	LVDS, YUV422 1280*1080@30fp.	
	View mode	Front view	







CATEGORY ITEM SPECIFICATION 1280(H) X 800(V), 1Mp Resolution Image Sensor 1/4" CMOS Mono Frame Rate 30fps View Angle H 85°±3°, V 53°±3° LVDS(POC) Output Format DC 8V(±0.5V) Power AP CPU Arm Cortex





CATEGORY	ITEM	SPECIFICATION
	MCU	32bit RISC CPU
	Max Register no.	6 ↑
	Interface	SPI
FINGERPRINT SENSING	OS	AUTOSAR
SYSTEM	Communication	CAN, SPI
1697.0733	FRR/FAR	FRR 1%, FAR 1/100,000↓
	Operating temp	-40~85℃
	-	-











CATEGORY	ITEM	SPECIFICATION
	Resolution	1280(H) X 800(V), 1Mp
	Image Sensor	1/4" CMOS Mono
	Frame Rate	30fps
CAMERA	View Angle	H 85°±3°, V 53°±3°
WENNESS.	Output Format	LVDS(POC)
	Power	DC 8V(±0.5V)
	(8)	180











CATEGORY	ITEM	SPECIFICATION	
	Fov	192°(H), 120°(V)	
LVDS	Pixel Resolution	1280 × 724p@30fps	
CAMERA	Video Output	LVDS (POC)	
	Approach	SVM, RVM	
	Fov	192°(H), 137°(V)	
ETHERNET	Pixel Resolution	on 1280 × 944p@30fps	
CAMERA	Video Output	Ethernet	
	Approach	SVM, RVM	
	Fov	192°(H)	
AHD	Pixel Resolution	1280 × 724p@30fps	
CAMERA	Video Output	AHD	
	Approach	RVM	















35 vehicle model 18 vehicle model

5 vehicle model

4 vehicle model

3 vehicle model 2 vehicle model

TOTAL 820 CAMERA MODELS **ANNUAL SHIPPING 5.0 MIL MODULES**

820 model camera moduleS development (supplying for all premium vehicles in Hyundai, KIA)

MILITARY VEHICLE HEAVY EQUIPMENT





CAMERA MODULE LINE-UP_FIXED FOCUS MODEL

	5M FF	5M FF	5M FF	5M FF
	COLUMN TO A STATE OF THE STATE		38°042	
F.NC	0_2.0 / FOV_68°	F.NO_2.4 / FOV_78°	F.NO_2.4 / FOV_85°	F.NO_2.2 / FOV_123°
	8M FF	12M FF	12M FF	13M FF
F.NC)_2.2/FOV_80°	E.NO_2.2 / FOV_120°	ENO_2.2 / FOV_123°	F.NO_2.0 / 78°
	16M FF	16M FF	24M FF	7
	53 foot	THE REFERENCE		



CAMERA MODULE LINE-UP_AUTO FOCUS MODEL

10M AF	10M AF	10M AF	13M AF
	E WINDS		
F.NO_2.2 / FOV_85°	F.NO_2.2 / FOV_80°	F.NO_2.4 / FOV_80°	F.NO_1.7 / FOV_75
13M AF	13M AF	40M AF	48M AF
			WELL THE STATE OF
F.NO_2.0 / FOV_76°	F.NO_1.9 / FOV_77°	F.NO_2.2 / FOV_80°	F.NO_1.8 / 80°
48M AF	64M AF		
	MAJEST WESTERNISH		
F.NO_2.0 / FOV_80°	F.NO_1.8/ FOV_81°		

CAMERA MODULE LINE-UP_OIS MODEL

	8M OIS	10M OIS	12M OIS	12M OIS
	35P3			
F	.NO_2.4 / FOV_32°	F.NO_2.4 / FOV_35°	F.NO_2.4 / FOV_76°	F.NO_2.4 / FOV_36°
	48M DIS	64M OIS	108M OIS	
		ATTAIN ATTAIN		
	The second state of	- passential,	t	
F	F.NO_1.8 / FOV_80°	F.NO_1.8/ FOV_81°	F.NO_1.8 / FOV_85°	

CAMERA MODULE LINE-UP_MULTI MODEL

65M AF / 12M AF	12M AF / 12M AF	64M AF / 12M FF / 5M FF	48M AF / 12M FF / 5M F
65M: F.NO_2.0 / FOV_76° 12M: F.NO_1.8 / FOV_79°	12M(L) : F.NO_2.2 / FOV_80° 12M(R) : F.NO_2.4 / FOV_120°	64M: F.NO_1.8 / FOV_81° 12M: F.NO_2.2/ FOV_123° 5M: F.NO_2.2 / FOV_84°	48M: F.NO_2.0 / FOV_80° 12M: F.NO_2.2/ FOV_123° 5M: F.NO_2.4 / FOV_78°
24M AF / 10M F	F / 8M FF / 5M FF	5M : F.NO_2.2 / FOV_84°	5M: F.NO_2.4 / FOV_78°
56			
	° / 10M : F.NO_2.4/ FOV_45° ° / 5M : F.NO_2.2 / FOV_85°		

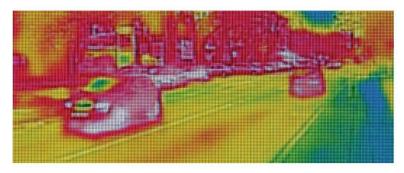


AF SPEC

OIS SPEC

THE OF EG			Old Ol Ed			
ITEM	UNIT	SPEC	ITEM	UNIT	SPEC	
Rated Stroke	um	Min 2410	Rated Stroke	Deg	Min 2.4 (±1.2)	
Hysteresis	um	Max 12	Hysteresis	Deg	Max 0.10	
Linearity	um	Max 20	Linearity	Deg	Max 0.11	
Holding Current	mA	Max 40	Max current	mA	Max 100	
Actuating Tilt	Min	Max 10	Phase margin	Deg	Min 25	
			Loop Gain	dB	Min 20	

TOTAL MOBILE SOLUTION **TOF** CAMERA









SPECIFICATION

ITEM	MIN	NORMAL	MAX	UNIT	REMARK
PKG Height	222	270	318	UM	
Ball Pitch X	3-3	500	e-	UM	
Ball Pitch Y	-	500	-	UM	
Total Ball Count	-	314	-	EA	
Resolution		320X240		PX	QVGA
Modulation frequency of VCSEL Driver	20		100	MHZ	
VCSEL wavelength		940		NM	

KEY FEATURES

	Removal of PCB, substrate-less		
Size	3D stacking of TOF sensor and the driver IC		
	Thickness reduction (>230um)/ Area reduction (>20%)		
Easy mounting	No Ceramic Carrier or substrate PCB needed		
Lasy mounting	Use ACF film or SMT process to electrically assemble the FOWLP onto the F-PCB		
Mass-production	The optical FOWLP is fabricated by the wafer level process with mass- production capability.		

TILT OIS

OUTSIDE VIEW AND FEATURE

Applying Module Tilt method result in NO Image Distortion

Module Tilt OIS: Vibration Reduction + External Tremors Reduction

Module Tilt method applied for mobile devices (Patent held by MCNEX)







SPECIFICATION



ITEM	CONDITION		
FOOT PRINT	A: 18.4 x 18.4 x 1.8H / B: 14.0 x 14.0 x 4.7H		
STABILIZING ANGLE	± 3deg		
MAX CURRENT	AF: 50mA / OIS: 100mA (TBD)		
PIXELS	48M		
SENSOR	SONY 1/2" 48Mega CMOS IMS586-AAJH5-S		
SENSOR SIZE	4.504mm(H) x 5.659mm(V)		
LENS	SUNNY 39256		
LENS SPEC	Ф8.25/6Р		
AF STROKE	380~430um		

USB CAMERA MODULE



5MP USB CAMERA BOARD

	Itesm	USB Camera SPEC
	Form factor	PCB Module Type
	PCB SIZE	50mm x 7mm x 0.8T
	Camera Resolution(MAX)	5MP(2592x1944)
	Image Sensor	1/5, Pixel size: 1.12um
	Video Max frame rate	30fps @ 5Mp (2592 x 1944) / 30fps @ quad HD (2560 x 1440
8	MIC	2MIC Support
	I/O Interface	USB 2.0
	Camera Interface(AP-Camera)	MIPI(CSI-2/4 lane)
E Face	Lens spec	4P, F2.4

8MP USB CAMERA BOARD



Itesm	USB Camera SPEC		
Form factor	PCB Module Type		
PCB SIZE	40mm x 12mm x1.0T		
Camera Resolution(MAX)	8MP(3264x2448)		
mage Sensor	1/4, 200um, Pixel size: 1.12um		
	MJPEG: 8MP 10fps @(3264x2448),4:3		
Video Max frame rate	5MP 10fps @(2592x1944)		
	2MP 60fps @(1600x1200) / YUY2: 5fps @(1600x1200)		
MIC	Option		
/O Interface	USB 2.0		
Camera Interface(AP-Camera)	MIPI(CSI-2/4 lane)		
Lens spec	4P, F2.2		

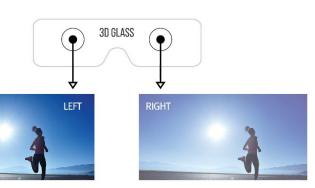
TOTAL MOBILE SOLUTION

3D DEPTH CAMERA



2 cameras can be actuated by one controller. This controller can mix 3D image without any other software 2D or 3D is optional.





SIDE BY SIDE (SHUTTER GLASS) IMAGE

As displaying right&left frame side by side, open and close a crystal shutter side by side to balance both sides of the frame timing



DUAL CAMERA MODULE

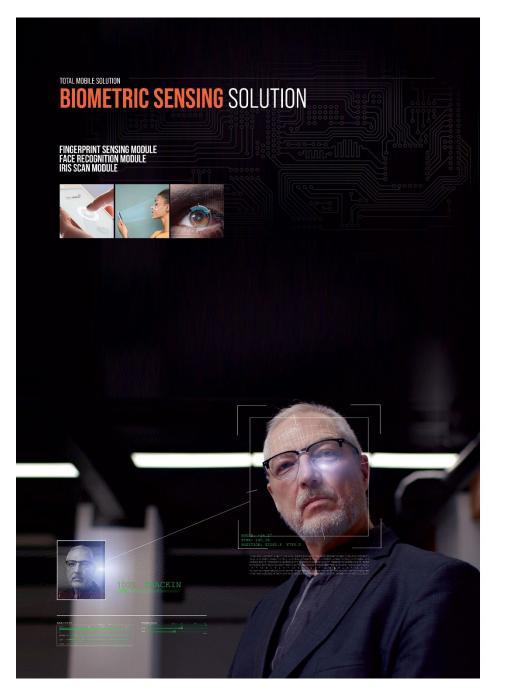


Application	AR, VR, MR, XR
Module Size	105mm x 10mm x 6.5mm
Pixel Size	1/4" CSP
Resolution	1 Mega pixel
I/F	USB3.0 & MIPI
F#	2.0
View Angle	180°
IR LED	850nm, 150°



ACTUATOR SOLUTION LINE-UP

PRODUCT	ТҮРЕ	RESOLUTION	DIMENSION
	CVCA (BALL)	40M	9.1X9.74 / 3.76T
	OIS (BALL)	64M	13.7X13.1 / 4.65T
	OIS (BALL)	12M	13.7X13.1 / 4.65T
	OIS (BALL)	10 M	11.1 X 11.1 / 5.65T
	OIS (BALL)	64M	13.5 X 13.5 / 4.8T
	OIS (BALL)	8M	10.0 X 10.0 / 4.3T
	OIS (BALL)	48M	12.5 X 12.1 / 4.3T
	OIS (BALL)	12M	11.3 X 11.7 / 3.95T
	OIS (BALL)	64M	13.5 X 13.5 / 4.8T
<	OIS (BALL)	50M	14.8 X 15.3 / 4.1T
	OIS (BALL)	12M 3X	11.1 X 11.1 / 5.15T
	OIS (BALL)	108M	13.9 X 13.9 / 4.8T
The same of the sa	ZOOM (BALL)	12M	36.2 X 14 X 6.2T
	OIS (BALL)	200M	18.0 X 18.7 X 4.9T



FINGERPRINT SENSING MODULE



CAPACITANCE FINGERPRINT SENSING MODULE



SPECIAL COATING TECHNOLOGY (NON-SPRAY COATING)

WIRE BONDING TECHNOLOGY FOR LOW LOOP CONTROL

SPECIALIZED PROCESS FOR FINGERPRINT SENSOR MODULE

GREAT PACKAGE PROCESSING AND INTERNALIZED PACKAGE

CAPACITANCE LINE UP













OPTICAL FINGERPRINT SENSING MODULE



HIGH VISIVILITY BY IN-DISPLAY TYPE

INSTINTIVE USAGE (DIRECT TOUCH TYPE TO OLED PANEL)

HIGHER RESOLUTION THAN CAPACITANCE TYPE: 750 Dpi

NO EFFECT TO OLED YIELD BECAUSE MODULE IS NOT CONTACT TO A PANEL.

OPTICAL LINE UP















BIOMETRIC SENSING SOLUTION FACE AUTHENTICATION SOLUTION





FEATURES

1:1M FAR (False Acceptance Rate)	Low cost design
Highly Secure : Encrypted feature points	Working in all lighting condition : indoor, outdoor, dark etc.
Strong anti-spoofing	Passed Google Certification Test
Vast and Unique 3D & 2D IR databases	

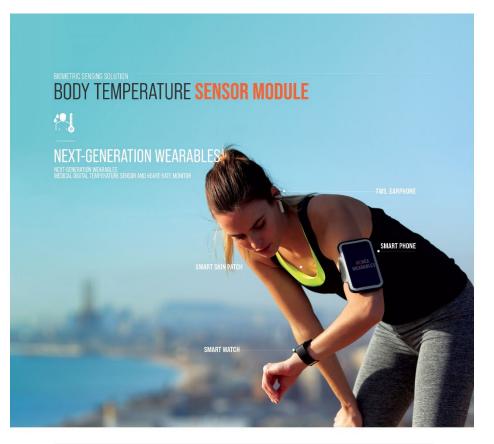
ITEM	CONDITION
SIZE(mm)	12.7 x 7.2 x 3.25t (Focus 60cm)
PIXEL	2M
SENSOR	OV02A10 (1/5*, 1.75μm)
Field of View	85.2°
F#	F2.0
TTL	2.7mm
	SIZE(mm) PIXEL SENSOR Field of View F#



FEATURES	HIGH SECURITY / HIGH RECOGNITION RATE	
Optimized Solution for "ALL EYE COLOR"	Unable to forge / falsify using photo, video, etc	
Applied IR-LED & Band pass filter of 810nm wavelength range	Low rate of error recognition	
Running VT / IRIS Camera via Switching function	Impossible to find same patterned iris	
High recognition rate regardless of light from indoor-outdoor	After infancy, iris is no longer changed	

SMART SECURITY





Very small size (for wearable)	Accurate non-contact temperature measurement
Health tracker	Optimization of space utilization

FEATURES

	SPEC
CH / FOV	4 Cell / 70°
Operating temperature	-20°C ~ 85°C
Medical accuracy	Satisfied
Interface I2C, VDD(3.3v),GND	
Module Size (mm)	5.20 x 13.32 x 1.78(t)
Deco Size (mm) 4.20 x 4.32	



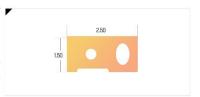
SKIN SENSOR



Very small size (for TWS)	SMD Type
Skin detector	Accurate skin contact / fabric contact detection

FEATURES

	SPEC	
CH / FOV	2 Ch	
Operating temperature	TBD	
Interface	I2C, VCC, GND	
Module Size (mm)	2.50 x 1.50 x 0.80(t)	



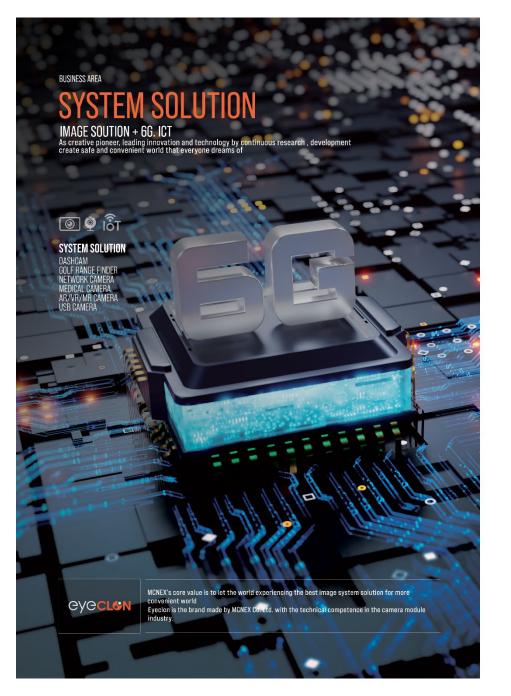
PPG MODULE HEART PULSE. BODY FAT SENSOR MODULE

Heart Pulse, Oxygen Saturation, Body Fat	Module Type	
Optical, Impedance Type	1Ch ~ 8Ch Custom	

FEATURES

	SPEC
PD CH	1Ch ~ 8 Ch
LED	Green, Red, IR
Operating temperature	-20 ℃ ~ + 60 ℃
Interface	SPI/I2C, VCC, INT, GND
Module Size (mm)	Design By Custom





DASHCAM DASHCAM





Model		MD-Q
Resolution		Front: 2560x1440/Rear: 1920x1080(2ch)
Image Sensor	Front	SC500AI / 135°(D) x 113°(H) x 61°(V) @30fps
iiilaye sensoi	Rear	SC223A (1/2.8")/ 146°(D) x 116°(H) x 62°(V) @30fps
LCD		2.0" TFT IPS LCD with Capacity Touch
GNSS		Built in support(GPS,BEIDOU,QZSS)
Memory Capacit	у	Micro SD Card up to 256GB
Motion detection	1	3 Axis Acceleration Sensor & Radar Sensor
Power		DC 12V/24V
Operating Temp		-20°C ~ 60°C
Dimension, weig	ht	56x42x29mm / 119g
ADAS		LDWS, FCWS, FVSA

SYSTEM SOLUTION DASHCAM

SYSTEM SOLUTION DASHCAM



L7PRIME LETE DASHCAM IMPLEMENTING WORLD FIRST SOUND PRESSURE SECURITY TECHNOLOGY FOR WARNING THEFT PROTECTION

INTRUDING PROTECTION	Detecting sound wave when intruding
THEFT PROTECTION	Warning when intruding into a car
ALRAMING CAR FIRE	Alarming when car is firing
IDENTIFYING PARKED LOCATION	Texting a parking location when parked
MANUAL RECORDING	Check the recorded video after manual recording by smart phone app.
DUAL BAND	LTE / WCDMA
CONTROLLING LOCATION/VIDEO/ STATUS	Check location and recorded video remotely



Model		CLON L7 PRIME
Resolution		Front: FHD1920x1080/Rear: 1280x720
Image Sensor	Front	1/2.9" CMOS Color Image Sensor
	Rear	1/4" CMOS Color Image Sensor
Frame Rate		30fps(Front & Rear)
View Angle		Front: 130°, Rear: 118°
LCD		3.5 inch HVGA
GPS		External
Memory Capacit	у	Micro SD Card Support up to 64GB
Power		DC 12V/24V, Super Cap
Operating Temp		-20°C ~ 60°C
Dimension(mm)		112 X 69 X 42mm / 175g
ADAS		LDWS, FCWS, FVSA, OBD II
LTE Feature		Real time monitoring and alarm via smartphone app





Model	MD-W
Size/Weight	59(W) x 43(H) x 29(D) / 75g
Micro SD card capacity	up to 256GB
Resolution	Front / Rear: FHD (1920 x 1080)
Front Camera	IMX 307 / 105° (H) x 56°(V) x 126°(D)
Rear Camera	IMX 323 / 105° (H) x 56°(V) x 126°(D)
Audio / Speaker	Embedded microphone / speaker
Frame Rate	Front / Rear : Max 30 Frame
Acceleration Sensor	3 Axic Acceleration Sensor
GPS	External GPS Port
Input Power Source	DC 12 / 24V
Auxiliary Power Unit	Super Capacitor
Operating Temp	-10°C ~ 60°C

SYSTEM SOLUTION DASHCAM







Model		MD-TX
Resolution		Front: 1920x1080/Rear: 1920x1080/Side: 1280x720
	Front	SC2315 1/2.7", 30fps, DFOV:150°
lmage Sensor	Side	C600, 30fps , DFOV:110°
	Rear	CS+F37, 30fps , DFOV:134°
LCD , GPS		4.0" TFT IPS LCD(800x480), External support
Memory Capacit	у	Micro SD Card up to 128GB
Power		DC 12V/24V
Operating Temp		-10°C ~ 60°C
Dimension(mm)		110X83.5X30mm
ADAS		LDWS, FVSA













C TIME LAPSE

CLON5000 2CH DASHCAM FHD+FHD



Model		CLON5000		
Resolution		Front: 1920x1080/Rear: 1920x1080		
I C	Front	SOI JX-F22 1/2.7" F2.0 @ 30fps, DFOV:14		
Image Sensor	Rear	SOI JX-F22 1/2.7" F2.0 @ 30fps, DFOV:140°		
LCD, GPS		3.5" TFT IPS LCD, External Support		
Memory Capacity		Micro SD Card up to 64GB		
Power		DC 12V/24V, Super Cap		
Operating Temp		-10°C ~ 60°C		
Dimension(mm)		98X63X32mm		
ADAS		LDWS, FCWS, FVSA		

CLON3000 2CH DASHCAM FHD+HD



Model Resolution		CLON3000		
		Front: 1920x1080/Rear: 1280x720		
Image Sensor	Front	SOI JX-F22 1/2.7" F2.0		
	Rear	SOI JX-H62 1/4" F2.0		
Frame Rate		30fps(Front & Rear)		
View Angle		Front: 140°, Rear: 120°		
LCD		3.5" TFT TN LCD		
GPS		External Support		
Memory Capacity		Micro SD Card up to 64GB		
Power		DC 12V/24V, Super Cap		
Operating Temp		-10°C ~ 60°C		
Dimension(mm)		98X63X32mm		
ADAS		LDWS, FCWS, FVSA		



F	FEATURES		
	High Quality Optical Lens(lens & Prism)		
	Bright adjustable 2Color OLED(Red, Green)		
	Calculate a distance reflecting altitude as supporting Slope Mode		
	High Speed measuring distance		
	Meter/Yard		
	High Accuracy		
	Water&dust proof: IP54		
	CR2 Battery(Replaceable)		
	Anti-hand shaking(Pin seeker , Jolt)		
	Slope mode/non slope mode/scan mode		
	Indicator LED(Slope mode: LED On)		

Itesm	Spec		
SIZE / Weight	107.35x38.17x69.03mm/T.B.D		
Battery	CR2		
View LCD	2Color OLED		
Range	0~1,200YD		
Accuracy	0.3YD~0.5YD~1YD		
Speed (sec)	0.15~0.35~0.55		
Optic zoom	X6		
FOV	7°		
Water/dust proof	IPX54		
Slope Mode	Support		
Operating Temp.	-20°C ~ 50°C		

٠	Measure a distance to a green hall by voice command
	Support multi satellite system, Gain over 24 satellites
	Map update through Blue Tooth
	Calculate a distance reflecting altitude
	Meter/Yard
	Measure a ball travel distance (Long Key)
	Setting menu on a smart phone by app.
	Auto detect a golf course and hall
	Select a green (left green/right green/both)
	Support Pogo charging port(Magnetic pogo type)

Itesm	Spec		
SIZE	Φ44~Φ35, 12.4mm(H)		
Weight	22.5g		
GPS	GPS, GLONASS, QZSS, BEIDOU		
Voice recognition	O ("Hi-Alice")		
BlueTooth	O (BLE 5.1)		
Battery	Chargeable Lithium Polymer		
Charging type	Pogo Cable 4pin 0hr~		
Operating time at full charging			
Trigger type for distance Guide	Voice command or Button		
I/F Wireless	Blue Tooth		
Cable	USB		

SMART MEDIA

SMART GLASSES



HIGHLY SIMPLIFIED OPTIC STRUCTURE TO ENSURE

- 1. High efficiency of image data transmitting
- 2. Unique system lens to deliver 2D and 3D images
- 3. Lighter and smaller smart glass device

CENTER-MOUNTED OPTIC MODULE TO PROVIDE

- 1. Wider view angle compared to side-mounted ones
- 2. Unique system lens to deliver 2D and 3D images
- 3. Fit in any stylish design for any application

CENTER-MOUNTED OPTIC MODULE

Our center-mounted optic module enables wide view angle for our glasses, solving one of the most difficult challenges faced by other smart glasses

Center-mounted optic module also allows us to design our glasses more stylish, compared to other models that are bulky and inconvenient to handle

BEST-IN-CLASS OPTIC DESIGN

Our patented technology enables us to use extremely thin beam splitter (2mm) as part of the optic module, making our glasses light weight and more comfortable to wear

Even with our minimum-sized optic module, the virtual images are created far enough from your eyes which makes refocusing of your eyesight unnecessary in order to view images



IOT. ICT CONVERGENCE OF IMAGE SOLUTION AND ICT TECHNOLOGY

INFORMATION COLLECTION

Gender, Age, number of visitors, Preference, purchase pattern, etc

INFORMATION ANALYSIS

Log server save, report date collection, data extraction

INFORMATION SEND

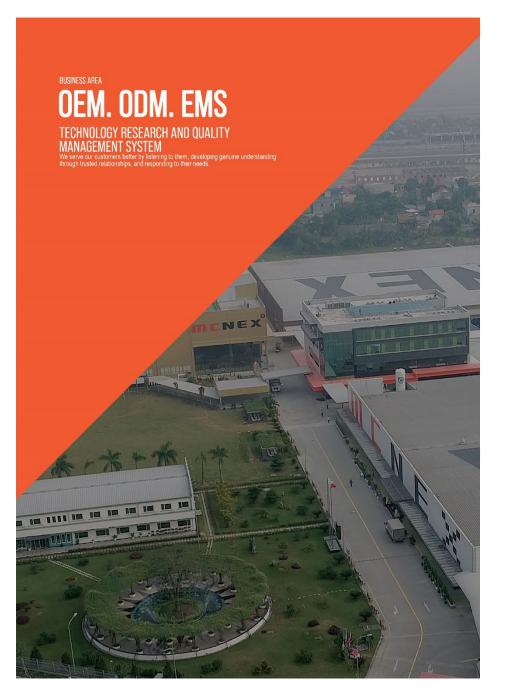
Emergency prevention, translating service, purchase service, visitor data, sales data provide, security, control, suggested service

SMART DID CES BOOTH IN 2019









VIETNAM FACTORY OVERVIEW



MANUFACTURING SITE	Phuc Son Industrial	Park, Ninh Binh City, Vietn	am		
FACTORY SIZE	Land A	rea	Building Area	Employees	
TAOTOTT SIZE	150,000 m°		127,338 m²	6,124	
ITEM & CAPACITY		0	(1) (1) (1) (1) (1) (1) (1) (1) (1) (1)		
	Mobile Camera	Actuator	Biometric	Automotive Camera	
	30M / Month	11M / Month	9M / Month	1.5M / Month	

CAPABLE OF RESPONDING TO THE VARIOUS NEEDS OF CUSTOMERS "NEW PRODUCTION AND TOLL PROCESSING AVAILABLE" AREA









2 FLOOR - 12,000 m2

3 FLOOR - 12,000 m²

DEM. DDM. EMS.

COMPETITIVENESS

VERIFIED QUALITY **MANAGEMENT** SYSTEM

Robust quality management system established through co-work with SAMSUNG, HKMC, Japan & US Customer + HKMC 5 Star (Quality system)

FACTORY SYSTEM, ERP. MES. PLM SYSTEM FULLY ESTABLISHED







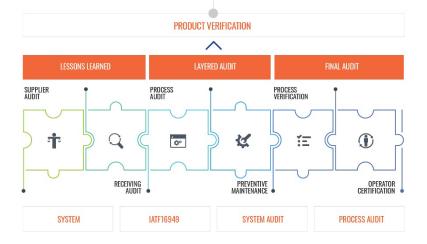
ERP (Enterprise Resource Planning) MES (Manufacturing Execution System) PLM (Product Lifecycle Management)

FACTORY CERTIFICATES

IATF16949 ISO14001 ISO45001

OHSAS18001 ISO26262

DEVELOPMENT / PRODUCTION QUALITY MANAGEMENT PROCESS



GLOBAL NETWORK - ON-TIME DELIVERY



Factory/R&D	Korea(Seoul), Vietnam(Hanoi)				
Sales office	Korea(Seoul), Vietnam(Hanoi), China(Shanghai), USA(San Jose), Japan, Taiwan				
Cost competitiveness	Factory located in bonded area Standard laboring days in Vietnam : 6days a week & Low labor				
Labor friendly factory	No laboring dispute since establishment of Vietnam Factory [2013 ~ now]				
environment	"Excellent enterprise award for labor environment"		MES System		
	Through FTA, can be shipped ar	ny country without worry	ing (US / CN / EU / AU / Pacific, etc.)		
Logistics advantages	Vietnam-US tariff agreement -> (Cheap tariff due to TPP contract)				
	Fast custom clearance : 1~2days earlier custom clearance than others(Factory located in bonded area)				

VARIOUS EXPERIENCE OF IMAGE SOLUTION TECHNOLOGY

Co-work with Microsoft for stereo camera development for AR, VR application Co-work with HKMC for ADAS camera system Selected as a standard module of iris recognition camera system into Qualcomm AP chip Development of camera system for ADAS application with TI, NXP & Socio Next AP Co-develop with Corephotonics for front camera Camera module development for Autonomous driving level 3 / Level 4 18 years of experience in the field of camera module: Single / Dual / Tri-Focal / Quadruple Abundant experience of government project for advanced technology